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Bib Data Sheet

CONFIRMATION NO. 5117

SERIAL NUMBER 10/803,192	FILING DATE 03/17/2004  RULE	CLASS 257	GROUP ART UNIT 2891	ATTORNEY DOCKET NO. 81754.0111
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APPLICANTS  
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\*\* CONTINUING DATA \*\*\*\*\* *DM*

\*\* FOREIGN APPLICATIONS \*\*\*\*\* *DM*  
 JAPAN 2003-078098 03/20/2003

IF REQUIRED, FOREIGN FILING LICENSE GRANTED  
 \*\* 08/25/2004

Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 (a-d) conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance Verified and Acknowledged	Examiner's Signature <i>[Signature]</i> Initials <i>DM</i>	STATE OR COUNTRY JAPAN	SHEETS DRAWING 4	TOTAL CLAIMS 20	INDEPENDENT CLAIMS 3
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TITLE  
 Semiconductor wafer, semiconductor device, method for manufacturing the semiconductor device, circuit board,  
 and electronic apparatus

FILING FEE  RECEIVED 920	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue )
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